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Product data sheet

1. General description

The 74HC194 is a 4-bit bidirectional universal shift register. The synchronous operation of the device is determined by the mode select inputs (S0, S1). In parallel load mode (S0 and S1 HIGH) data appearing on the D0 to D3 inputs, when S0 and S1 are HIGH, is transferred to the Q0 to Q3 outputs. When S0 is HIGH and S1 is LOW data is entered serially via DSL and shifted from left to right; when S0 is LOW and S1 is HIGH data is entered serially via DSR and shifted from right to left. DSR and DSL allow multistage shift right or shift left data transfers without interfering with parallel load operation. If both S0 and S1 are LOW, existing data is retained in a hold mode. Mode select and data inputs are edge-triggered, responding only to the LOW-to-HIGH transition of the clock (CP). Therefore, the only timing restriction is that the mode control and selected data inputs must be stable one set-up time prior to the positive transition of the clock pulse. When LOW, the asynchronous master reset (MR) overrides all other input conditions and forces the Q outputs LOW. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

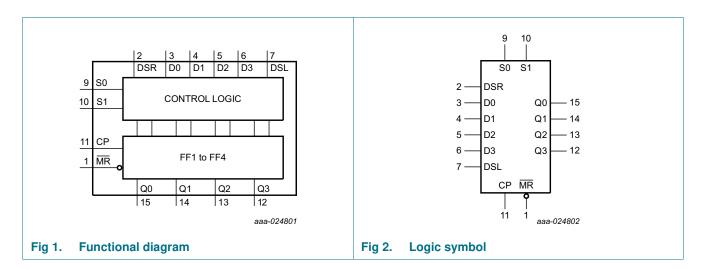
- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC194: CMOS level
- Shift-left and shift right capability
- Synchronous parallel and serial data transfer
- Easily expanded for both serial and parallel operation
- Asynchronous master reset
- Hold ('do nothing') mode
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

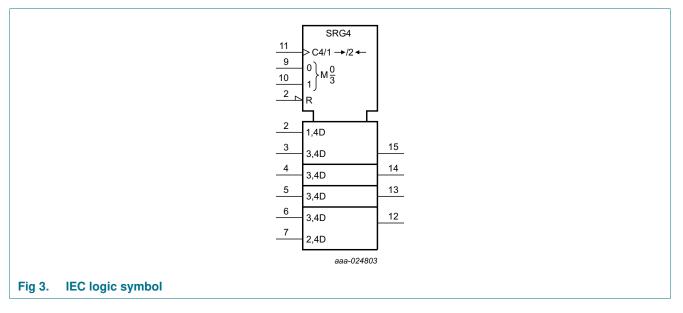


Ordering information 3.

Table 1. Ord	Table 1. Ordering information										
Type number Package											
	Temperature range	Name	Description	Version							
74HC194D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1							
74HC194DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1							

Functional diagram 4.

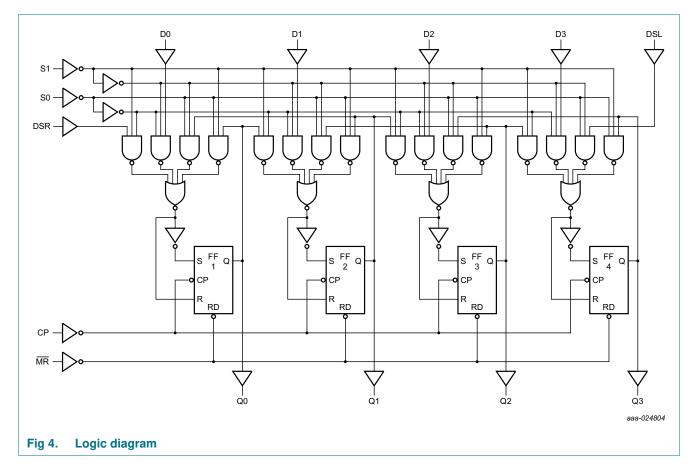




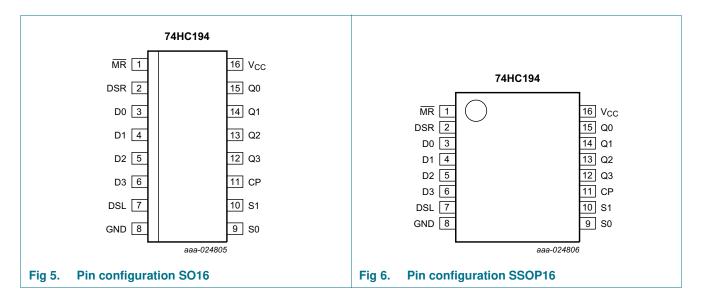
NXP Semiconductors

74HC194

4-bit bidirectional universal shift register



5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2.	Pin description
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Symbol	Pin	Description
MR	1	asynchronous master reset (active LOW)
DSR	2	serial data input (shift right)
D0, D1, D2, D3	3, 4, 5, 6	parallel data inputs
DSL	7	serial data input (shift left)
GND	8	ground (0 V)
S0, S1	9, 10	mode control inputs
CP	11	clock input (LOW-to-HIGH, edge triggered)
Q0, Q1, Q2, Q3	15, 14, 13, 12	parallel outputs
V _{CC}	16	positive supply voltage

6. Functional description

Table 3. Function table^[1]

Operating mode	Inputs							Outpu	Outputs			
	СР	MR	S1	S0	DSR	DSL	Dn	Q0	Q1	Q2	Q3	
Reset (clear)	Х	L	Х	Х	Х	Х	Х	L	L	L	L	
Hold (do nothing)	Х	Н	I	I	Х	Х	Х	q0	q1	q2	q3	
Shift left	\uparrow	Н	h	I	Х	I	Х	q1	q2	q3	L	
	\uparrow	Н	h	I	Х	h	Х	q1	q2	q3	Н	
Shift right	\uparrow	Н	I	h	I	Х	Х	L	q0	q1	q2	
	\uparrow	Н	I	h	h	Х	Х	Н	q0	q1	q2	
Parallel load	↑	Н	h	h	Х	Х	dn	d0	d1	d2	d3	

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition;

L = LOW voltage level;

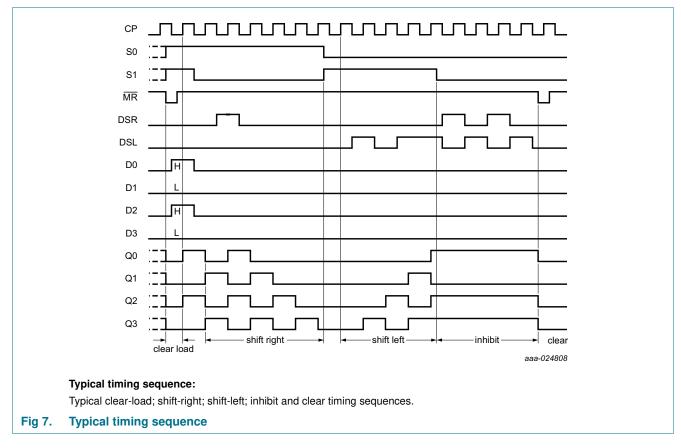
I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;

q, d = lower case letters indicate the state of the referenced input (or output) one set-up time prior to the LOW-to-HIGH CP transition; X = don't care;

 \uparrow = LOW-to-HIGH clock transition.

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4-bit bidirectional universal shift register



7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V		-	±20	mA
I _{OK}	output clamping current	$V_{\rm O} < -0.5$ V or $V_{\rm O} > V_{\rm CC}$ + 0.5 V		-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	+50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO16 package	<u>[1]</u>	-	500	mW
		SSOP16 package	<u>[1]</u>	-	500	mW

[1] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.

For SSOP16 packages: above 60 $^\circ\text{C}$ the value of P_{tot} derates linearly at 5.5 mW/K.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C te	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -20 \ \mu A; V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 6.0 \ V \end{array}$	-	-	8.0	-	80.0	-	160.0	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

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4-bit bidirectional universal shift register

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see <u>Figure 12</u>.

Symbol	Parameter	Conditions		25 °C		–40 °C to	o +85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	-
t _{pd}	propagation	CP to Qn; see Figure 8 [1]								-
	delay	V _{CC} = 2.0 V	-	47	145	-	180	-	220	ns
		V _{CC} = 4.5 V	-	17	29	-	36	-	44	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	14	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	25	-	31	-	38	ns
t _{PHL}	High to LOW propagation delay	MR to Qn; see Figure 9								-
		V _{CC} = 2.0 V	-	39	140	-	175	-	210	ns
		V _{CC} = 4.5 V	-	14	28	-	35	-	42	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	11	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	11	24	-	30	-	36	ns
t _t transition	see Figure 8 [2]								-	
	time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		$V_{\rm CC} = 6.0 \ {\rm V}$	-	6	13	-	16	-	19	ns
tw	pulse width	CP HIGH or LOW; see Figure 8								-
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
tw	pulse width	MR pulse width LOW; see Figure 9								
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
t _{rec}	recovery	MR to CP; see Figure 9								1
	time	V _{CC} = 2.0 V	60	17	-	75	-	90	-	ns
		V _{CC} = 4.5 V	12	6	-	15	-	18	-	ns
		$V_{CC} = 6.0 V$	10	5	-	13	-	15	-	ns

4-bit bidirectional universal shift register

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{su}	set-up time	Dn to CP; see Figure 10								
		V _{CC} = 2.0 V	70	17	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	6	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	5	-	15	-	18	-	ns
		S0, S1 to CP; see Figure 11								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	12	6	-	17	-	20	-	ns
	DSR, DSL to CP; see Figure 10								-	
	V _{CC} = 2.0 V	70	19	-	90	-	105	-	ns	
		V _{CC} = 4.5 V	14	7	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	6	-	15	-	18	-	ns
t _h hold time	hold time	Dn to CP; see Figure 10								
		V _{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-4	-	0		0	-	ns
		S0, S1 to CP; see Figure 11								
		V _{CC} = 2.0 V	0	-11	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-4	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-3	-	0		0	-	ns
		DSR, DSL to CP; see Figure 10								-
		V _{CC} = 2.0 V	0	-17	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-6	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-5	-	0		0	-	ns
f _{max}	maximum	CP; see Figure 8								
	frequency	V _{CC} = 2.0 V	6	31	-	4.8	-	4	-	MHz
		V _{CC} = 4.5 V	30	93	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	102	-	-	-	-	-	MHz
		$V_{CC} = 6.0 V$	35	111	-	28	-	24	-	MHz

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see <u>Figure 12</u>.

4-bit bidirectional universal shift register

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	$V_i = GND$ to V_{CC} ; $f_i = 1 \text{ MHz}$ 3	-	40	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz;

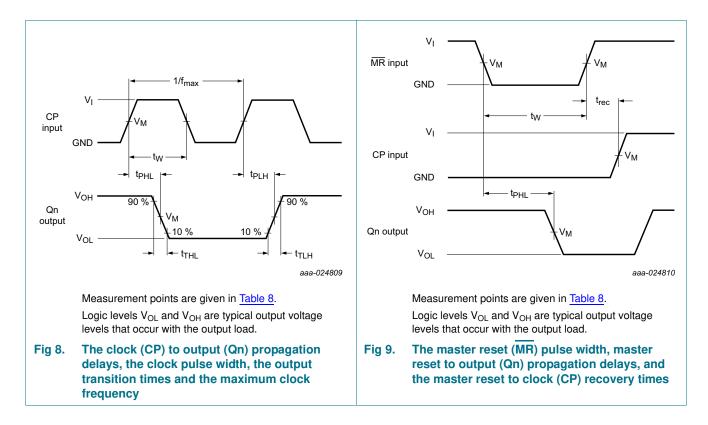
 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

11. Waveforms



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4-bit bidirectional universal shift register

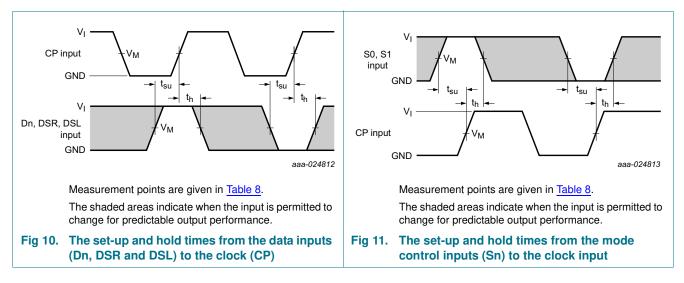


Table 8.Measurement points

Input		Output
V _M	Vi	V _M
$0.5 \times V_{CC}$	GND to V _{CC}	$0.5 \times V_{CC}$

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74HC194

4-bit bidirectional universal shift register

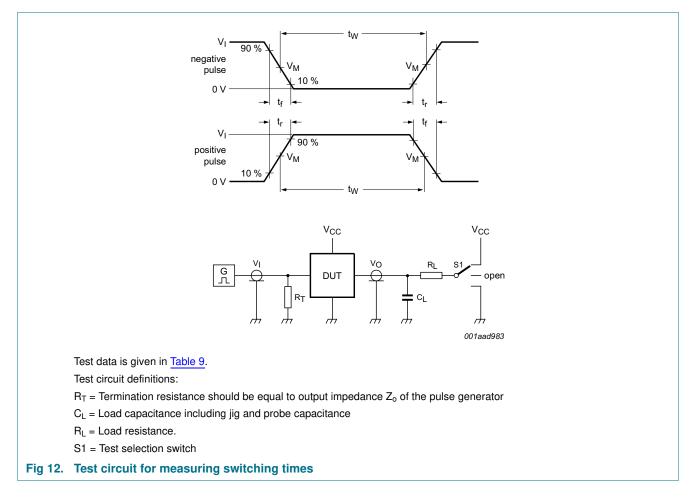


Table 9. Test data

Input		Load	S1 position		
VI	t _r , t _f	C _L R _L t		t _{PHL} , t _{PLH}	
V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	

4-bit bidirectional universal shift register

12. Package outline

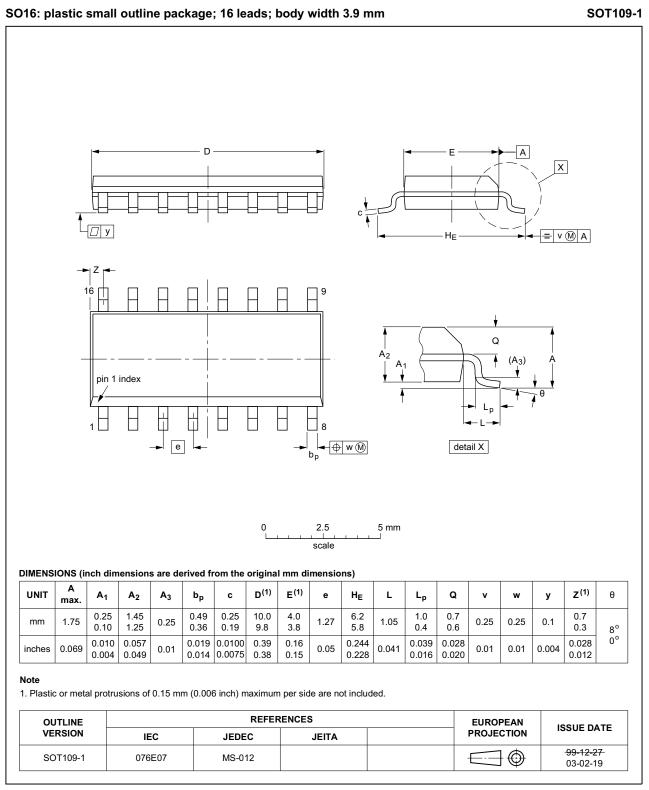


Fig 13. Package outline SOT109-1 (SO16)

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4-bit bidirectional universal shift register

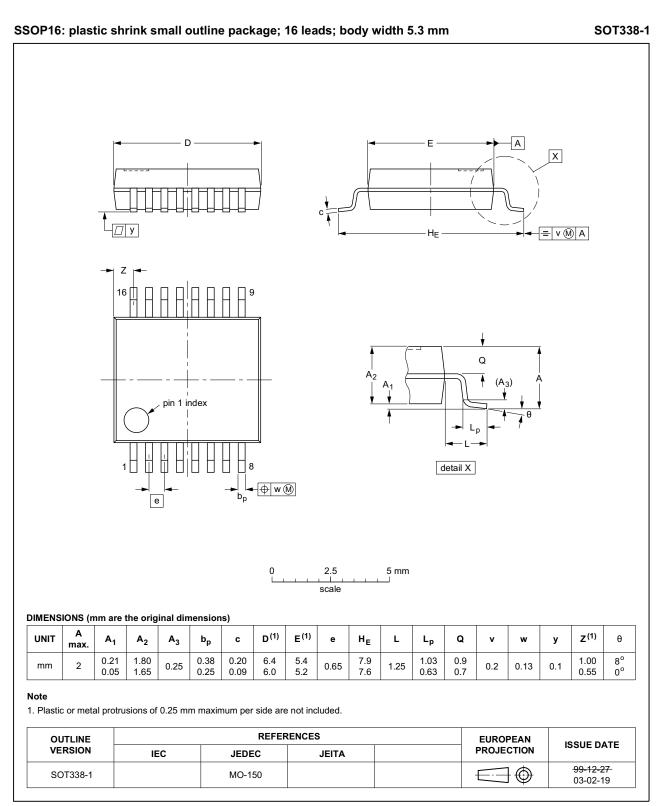


Fig 14. Package outline SOT338-1 (SSOP16)

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13. Abbreviations

Table 10. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MM	Machine Model	

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC194 v.3	20161129	Product data sheet	-	74HC_HCT194 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 			th the new identity	
	Legal texts have been adapted to the new company name where appropriate.				
	Type numbers 74HC194N, 74HCT194N and 74HCT194D removed.				
74HC_HCT194 v.2	19901201	Product specification	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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4-bit bidirectional universal shift register

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